

KEMET Part Number: C0805C472G3GECTU
(C0805C472G3GEC7800)

ESD SMD Comm C0G, Ceramic, Electro Static Discharge, 4700 pF, 2%, 25 VDC, C0G, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 0805



| Dimensions | |
|------------|-----------------|
| L | 2mm +/-0.2mm |
| W | 1.25mm +/-0.2mm |
| T | 0.9mm +/-0.10mm |
| S | 0.75mm MIN |
| B | 0.5mm +/-0.25mm |

| Packaging Specifications | |
|----------------------------|------------------------|
| Packaging: | T&R, 180mm, Paper Tape |
| Packaging Quantity: | 4000 |

| General Information | |
|---------------------|--|
| Supplier: | KEMET |
| Series: | ESD SMD Comm C0G |
| Style: | SMD Chip |
| Description: | SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I |
| Features: | Temperature Stable, Low ESR, Class I |
| RoHS: | Yes |
| Termination: | Tin |
| Marking: | No |
| Chip Size: | 0805 |

| Specifications | |
|---|---------------------|
| Capacitance: | 4700 pF |
| Capacitance Tolerance: | 2% |
| Voltage DC: | 25 VDC |
| ESD Level per AEC-Q200: | 25,000 V ESD Level |
| Dielectric Withstanding Voltage: | 62.5 V |
| Temperature Range: | -55/+125C |
| Temperature Coefficient: | C0G |
| Dissipation Factor: | 0.10% 1kHz 25C |
| Aging Rate: | 0% Loss/Decade Hour |
| Insulation Resistance: | 100 GOhms |